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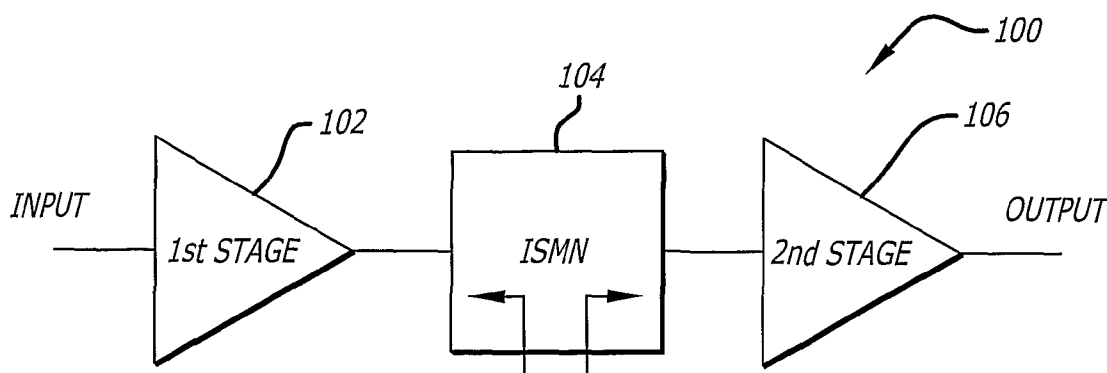
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(54) Title: TWO STAGE MICROWAVE CLASS E POWER AMPLIFIER



(57) Abstract: A load circuit (40) for use with a switching mode circuit (50). The novel load circuit (40) includes a series inductive-capacitive network (32, 34) coupled to an output of the switching mode circuit (50) and a circuit (42) for providing a capacitance coupled to the output of the switching mode circuit (50). In an illustrative embodiment, the circuit (42) for providing capacitance includes one or more lumped capacitors adapted to compensate for an intrinsic capacitance in the switching mode circuit (50). The load circuit (40) may also include a shunt inductance coupled to the output of the switching mode circuit. In an illustrative embodiment, the load circuit (40) is adapted to provide a Class-E load to a two-stage high power amplifier (100). The amplifier (100) includes a driver stage (102), a novel Class-E inter-stage matching network (ISMN) (104), and a high power stage (106) using the novel load circuit (40).



WO 2007/008349 A1

**TWO STAGE MICROWAVE
CLASS E POWER AMPLIFIER**

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BACKGROUND OF THE INVENTION

10 Field of the Invention:

The present invention relates to electrical and electronic circuits and systems. More specifically, the present invention relates to microwave Class E power amplifiers.

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Description of the Related Art:

Highly efficient microwave and radio frequency (RF) high power amplifiers are required for many commercial and military applications. Typical applications include wireless local area networks, cellular phones and telecommunication systems, as well as advanced airborne active phased array radar systems. Class-E power amplifiers are high-efficiency amplifiers that would be useful for these and other applications.

Class-E amplifiers are part of the “switching mode amplifiers” such as class D, E, F, etc. These types of amplifiers include a transistor that operates as a perfect switch with no overlapping voltage and current waveforms at its output terminal, thereby ideally dissipating zero DC power. Other classes of amplifiers such as class A, A/B and C, operate as current-sources with overlapping voltage and current waveforms and hence dissipate DC power, leading to a lower efficiency.

30 A Class-E amplifier typically consists of a single transistor and a resonant load

network. The function of the load network is to shape the voltage and current waveforms at the active device output terminal to prevent simultaneous high voltage and high current in the transistor, thereby minimizing DC power dissipation. The active device acts as a switch, driven by an RF input signal to "ON" and "OFF" conditions. The operating point of the device is such that the device is either OFF (in the pinched-off region) or ON (in the linear region). Under an ideal switching operation condition, output voltage and current waveforms at the device output terminal do not exist simultaneously and, therefore, the energy dissipated within the device is zero, yielding a 100 percent theoretical power conversion efficiency.

10 Present class-E high power amplifiers (HPAs) have limited useful bandwidth due to their highly tuned load circuits. Class-E HPAs have generally been used at audio, HF and UHF frequencies for applications such as audio HI-FI systems, Ham radios and high power plasma generation where narrow frequency bandwidth are required. In recent years, the published work on monolithic class-E power amplifiers has been limited to narrow band (less than 500 MHz) RF frequencies covering the hand set cell phone market.

In addition, conventional class-E amplifiers have limited power outputs. Class-E amplifiers are typically implemented using single stage designs. In order to increase gain, the size of the amplifier's active device is increased. Increasing the active device, however, reduces the frequency range of the amplifier due to the increased capacitance at the input of the device.

Hence, a need exists in the art for an improved Class-E amplifier offering simultaneous high power and high power added efficiency (PAE) over a broader frequency range.

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SUMMARY OF THE INVENTION

The need in the art is addressed by the load circuit of the present invention.

5 The novel load circuit is adapted for use with any switching mode circuit and includes a series inductive-capacitive network coupled to an output of the switching mode circuit and a circuit for providing a capacitance coupled to the output of the switching mode circuit. In an illustrative embodiment, the circuit for providing capacitance includes one or more lumped capacitors adapted to compensate for an intrinsic capacitance in

10 the switching mode circuit. The load circuit may also include a shunt inductance coupled to the output of the switching mode circuit.

In an illustrative embodiment, the load circuit is adapted to provide a Class-E load to a two-stage Class-E high power amplifier. The amplifier includes a driver stage, a novel Class-E inter-stage matching network (ISMN), and a high power stage

15 using the novel load circuit. The novel ISMN includes a first circuit for providing a Class-E load to the amplifier driver stage and a second circuit for providing a matched input impedance for the high power stage. The load circuit and the ISMN are both adapted to provide simultaneous high power added efficiency and high power over a broad frequency range.

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BRIEF DESCRIPTION OF THE DRAWINGS

25 Fig. 1 is a simplified block diagram of an illustrative embodiment of a two-stage Class-E high power amplifier designed in accordance with the teachings of the present invention.

Fig. 2a is a simplified schematic diagram of a discrete component implementation of an amplifier with a conventional Class-E load.

30 Fig. 2b is a distributed component implementation of the conventional Class-E

load depicted in Fig. 2a.

Fig. 3 is a simplified schematic diagram of a discrete component implementation of a prior art broadband Class-E load network.

5 Fig. 4 is a simplified schematic diagram of a discrete component implementation of an illustrative embodiment of a Class-E load network designed in accordance with the teachings of the present invention.

Fig. 5 is a distributed component implementation of the Class-E load depicted in Fig. 4.

10 Fig. 6 is a graph showing the frequency response of the distributed load of Fig. 5.

Fig. 7 is a representation of a Class-E ISMN in accordance with the teachings of the present invention.

15 Fig. 8a is a simplified schematic diagram showing a distributed component implementation of an illustrative embodiment of the first amplifier stage and a first circuit of the Class-E ISMN designed in accordance with the teachings of the present invention.

20 Fig. 8b is a simplified schematic diagram showing a distributed component implementation of an illustrative embodiment of a second circuit of the Class-E ISMN and the second amplifier stage designed in accordance with the teachings of the present invention.

DESCRIPTION OF THE INVENTION

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Illustrative embodiments and exemplary applications will now be described with reference to the accompanying drawings to disclose the advantageous teachings of the present invention.

30 While the present invention is described herein with reference to illustrative embodiments for particular applications, it should be understood that the invention is not

limited thereto. Those having ordinary skill in the art and access to the teachings provided herein will recognize additional modifications, applications, and embodiments within the scope thereof and additional fields in which the present invention would be of significant utility.

5 Fig. 1 is a simplified block diagram of an illustrative embodiment of a two-stage Class-E high power amplifier 100 designed in accordance with the teachings of the present invention. The circuit 100 is specifically synthesized for high power operation (5.0 W -10.0 W or greater), providing a simultaneous high power added efficiency (PAE) and high power over a broad frequency range (7-11 GHz). The amplifier 100
10 includes a driver stage (first stage) 102, a high power stage (second stage) 106, and a novel class-E inter-stage matching network (ISMN) 104 situated between the two stages. Both stages of the amplifier 100 possess unique broadband class-E loads. This design approach is contrary to the conventional class A/B HPA designs in which the driver stage is designed to operate in the linear region.

15 The two-stage Class-E high power amplifier (HPA) of the present invention includes a novel Class-E load designed to maintain simultaneous high power and high PAE over a broad bandwidth. Fig. 2a is a simplified schematic diagram of a discrete component implementation of an amplifier 10 with a conventional Class-E load 20. As shown in Fig. 2a, a typical Class-E amplifier 10 includes a transistor represented
20 by a switch 12, coupled to a voltage source V_{ds} via an inductive bias line 14. The switch 12 is also coupled to a resistive load 24 via a capacitor 22 and an inverted L type (series L, shunt C) wave shaping load network 20. The conventional Class-E load network 20 includes a first shunt capacitor 15, which is the drain to source capacitance (C_{ds}) of the transistor switch 12, and a series inductor 16 followed by a
25 shunt capacitor 18. Few design efforts have been made to optimize these circuits for broadband operation. Hence, in previous amplifier designs, the drain bias line 14 was treated independent of the load circuit 20, merely acting as a choke realized by a quarter wavelength length of transmission line.

Fig. 2b is a distributed component implementation of the conventional Class-E
30 load depicted in Fig. 2a. It is worth mentioning that the function of the load network

in the class E amplifier is to shape the voltage and current waveforms. Therefore, for the design of a broadband Class-E amplifier, care should be taken to ensure Class-E waveforms exist over the entire frequency band. Conventional Class-E load circuits are operable only over a narrow bandwidth (about 500 MHz or less).

5 Fig. 3 is a simplified schematic diagram of a discrete component implementation of a prior art broadband Class-E load network 30, as described in a patent application entitled "BROADBAND MICROWAVE AMPLIFIER", Serial No. 11/054,968, filed February 10, 2005, by R. Tayrani (Atty. Docket No. PD 04W178), the teachings of which are incorporated herein by reference. This load topology is based on a series L-C (inductive-capacitive) network, and includes an inductive
10 element 32 connected in series with a capacitive element 34 between the transistor output terminal 36 and the resistive load 24. The drain bias line is also included in the load design process as a shunt inductive element 14 coupled to the transistor output terminal 36. The intrinsic capacitance C_{ds} of the active device is represented as a
15 shunt capacitor 15 coupled to the transistor output terminal 36.

 While this design provides superior broadband performance for medium power applications, it may not be as effective for high power amplifiers. In order to achieve greater RF power, a high power amplifier typically includes a larger active device (gate periphery greater than 5.0 mm), which generally is realized by
20 combining several active devices in parallel. However, care must typically be taken in combining active devices in parallel as it may reduce the useful frequency range of the amplifier due to the intrinsic capacitance and other associated device extrinsic parasitics, thereby further reducing the operational bandwidth of the circuit.

 In accordance with the teachings of the present invention, auxiliary capacitors are
25 added to a series L-C load network to compensate for the intrinsic capacitance of the active device. Fig. 4 is a simplified schematic diagram of a discrete component implementation of an illustrative embodiment of a Class-E load network 40 designed in accordance with the teachings of the present invention. The novel load network 40 includes one or more lumped capacitors 42 coupled to the output terminal 36 of the
30 active device. The lumped capacitors 42 are designed to compensate for the intrinsic

active device capacitance C_{ds} (represented in Fig. 4 as a shunt capacitor 15 coupled to the transistor output terminal 36). An inductive element 32 is connected in series with a capacitive element 34 between the transistor output terminal 36 and a broadband impedance transformer 44. The impedance transformer 44 transforms the output impedance of the circuit to match the impedance of the resistive load 24, which in the illustrative embodiment is 50.0 Ohms. The drain bias line is also included in the load design process as a shunt inductive element 14 coupled to the transistor output terminal 36.

The lumped load shown in Fig. 4 has to be transformed to its equivalent distributed network to render it useful for application at X-band and other microwave frequency bands. To optimize the distributed load for Class-E operation, a time domain optimization process is performed. Further details on a design methodology for broadband circuits can be found in the above referenced patent application.

Fig. 5 is a distributed component implementation of the Class-E load depicted in Fig. 4. The load network 40 shown in Fig. 5 is designed for use in the second stage 106 of the novel high power amplifier 100 of Fig. 1. In the illustrative embodiment, the second amplifier stage 106 includes four transistors 50A, 50B, 50C, and 50D connected in parallel. The outputs (drains) of the transistors are connected together at node 36. In this embodiment, the load network 40 includes two adjustable lumped capacitors 42A and 42B coupled to node 36. Two bias drain lines 14A and 14B couple the transistor output node 36 to voltage sources V1 and V2, respectively. The series L-C network is implemented by two transmission lines 52A and 52B, which couple the transistor output node 36 to a three-port capacitor 54. A transmission line 56 couples the three-port capacitor 54 to the impedance transformer 44. The impedance transformer 44 is implemented using two transmission lines 58 and 60 connected in series between line 56 and an output terminal 62. A shunt capacitor 64 is connected between lines 56 and 58, and a shunt capacitor 66 is connected between lines 58 and 60. Illustrative values for the width and length dimensions of the transmission lines are shown in microns in Fig. 5. Other implementations may also be used without departing from the scope of the present teachings.

The novel Class-E load 40 of the present invention is suitable for high power operation, and is especially useful for large active devices, as used in the second stage of the illustrative HPA of Fig. 1. The circuit 40 provides a simultaneous high PAE and high power over a broadband frequency range (7-11 GHz in the illustrative embodiment). Fig. 6 is a graph showing the frequency response of the distributed load 40 of Fig. 5, illustrating a broadband nearly frequency independent phase and magnitude response over the frequency range 7-11 GHz. This type of frequency response is the necessary requirement to the broadband operation of a Class-E HPA. Those of ordinary skill in the art may extend the present teachings to other frequencies without departing from the scope thereof.

Returning to Fig. 1, the two-stage Class-E high power amplifier 100 of the present invention also includes a novel Class-E inter-stage matching network (ISMN) 104 designed to maintain simultaneous high power and high PAE over a broad bandwidth. An ISMN is necessary when designing a two-stage amplifier. The ISMN circuit could be said is similar to a band-pass filter having unequal complex loads at its input/output ports. In the case of the Class-E ISMN circuit 104, the complex load has to be a frequency independent Class-E load. This load (which is the Class-E load for the first amplifier stage 102) then is matched to the complex input impedance of the second amplifier stage 106 over the desired bandwidth. Fig. 7 is a representation of a Class-E ISMN 104, illustrating this concept.

The novel Class-E ISMN 104 includes a first circuit 110 for providing a Class-E load to the first amplifier stage 102, and a second circuit 112 for providing a matched input impedance for the second amplifier stage 106. Figs. 8a and 8b show the details for the novel two-stage Class-E HPA 100 of the present invention: Fig. 8a shows the first amplifier stage 102 and the first portion 110 of the ISMN, and Fig. 8b shows the second portion 112 of the ISMN and the second amplifier stage 106.

Fig. 8a is a simplified schematic diagram showing a distributed component implementation of an illustrative embodiment of the first amplifier stage 102 and first circuit 110 of the Class-E ISMN designed in accordance with the teachings of the present invention. The first amplifier stage 102 includes an active device 124 and an

input matching network 122 for coupling an input terminal 120 to the input of the active device 124. In the illustrative embodiment, the active device 124 is a pseudo-morphic, high-electron mobility transistor (pHEMT). The output (drain) of the active device 124 is connected to the first circuit 110 of the ISMN.

5 The first circuit 110 of the ISMN provides a broadband Class-E load to the first amplifier stage 102. In the illustrative embodiment, the circuit 110 is based on a series L-C network and includes a transmission line 128 connected in series with a capacitive element 130 between the active device output 126 and a node 132. Two transmission lines 134 and 136 are connected in series between the transistor output 126 and a voltage
10 supply V3. A shunt capacitor 144 is coupled between the lines 134 and 136. Three transmission lines 138, 140 and 142 are connected in series between the transistor output 126 and ground.

 Optionally, the first circuit 110 of the ISMN may also include auxiliary lumped capacitors coupled to the transistor output 126 to compensate for the intrinsic capacitance
15 of the active device 124. The first circuit 110 of the ISMN thus uses a similar approach as the Class-E load described above. In the illustrative embodiment, auxiliary capacitors are not needed in the ISMN because the first amplifier stage 102 is a driver stage providing lower power (and therefore a smaller active device 124) than the second amplifier stage 106. The addition of auxiliary lumped capacitors to the first circuit 100
20 of the ISMN may be desirable for a higher power first amplifier stage or for higher frequency operation.

 Fig. 8b is a simplified schematic diagram showing a distributed component implementation of an illustrative embodiment of the second circuit 112 of the Class-E ISMN and the second amplifier stage 106 designed in accordance with the teachings of
25 the present invention. In the illustrative embodiment, the second amplifier stage 106 includes four active devices 50A, 50B, 50C, and 50D connected in parallel, and a broadband Class-E load 40, the details of which were shown in Fig. 5. In the illustrative embodiment, the active devices 50A, 50B, 50C, and 50D are implemented using pHEMTs.

30 The second circuit 112 of the ISMN provides matched input impedances to the

inputs of the active devices 50A, 50B, 50C, and 50D in the second amplifier stage 106. In the illustrative embodiment, the second circuit 112 includes four transmission lines 150, 152, 154, and 156 connected in series between the node 132 and the input of the transistor 50A. A three-port junction 158 connects the lines 154 and 156 to a transmission line 160, which is coupled to a voltage supply V5. A shunt capacitor 162 is coupled between lines 150 and 152, and a shunt capacitor 164 is coupled between lines 152 and 154. A shunt capacitor 166 is coupled to node 132. Two transmission lines 170 and 172 are connected in series between the capacitor 162 and the input of transistor 50B. A shunt capacitor 174 is coupled between lines 170 and 172.

10 Similarly for the other two transistors, four transmission lines 180, 182, 184, and 186 are connected in series between the node 132 and the input of the transistor 50D. A three-port junction 188 connects the lines 184 and 186 to a transmission line 190, which is coupled to a voltage supply V6. A shunt capacitor 192 is coupled between lines 180 and 182, and a shunt capacitor 194 is coupled between lines 182 and 184. Two transmission lines 200 and 202 are connected in series between the capacitor 192 and the input of transistor 50C. A shunt capacitor 204 is coupled between lines 200 and 202.

20 Thus, the present teachings provide an efficient high power, broadband HPA by synthesizing a new class of miniature broadband Class-E loads that are technology independent and therefore are suitable for monolithic integration in GaAs, GaN and/or SiGe MMIC technologies. The most important properties of these new loads are their ability to provide a simultaneous PAE and power over the entire bandwidth. In a preferred embodiment, the HPA is designed using a circuit simulation technique including time domain analysis, Harmonic Balance analysis, large signal stability analysis, and envelop simulation. By applying these new circuits and their associated unique design methodology for the design of switching mode power amplifiers, highly efficient (PAE>80 at X-band) HPAs can be designed.

25 Thus, the present invention has been described herein with reference to a particular embodiment for a particular application. Those having ordinary skill in the art and access to the present teachings will recognize additional modifications, applications and embodiments within the scope thereof. For example, the present

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teachings are not limited to Class-E amplifiers. That is, the present teachings may be used in connection with any switching amplifier or circuit design.

It is therefore intended by the appended claims to cover any and all such applications, modifications and embodiments within the scope of the present invention.

5 Accordingly,

[EUROSTYLE] CLAIMS

1. A load circuit (40) for use with a switching mode circuit (50) characterized by:
a series inductive-capacitive network (32, 34) coupled to an output of said switching mode circuit (50) and
5 one or more lumped capacitors (42) coupled to said output of said switching mode circuit (50).
2. The invention of Claim 1 wherein said capacitors (42) compensate for an intrinsic capacitance in said switching mode circuit (50).
3. The invention of Claim 1 wherein said load circuit (40) further includes an impedance transformer (44) coupled to said series inductive-capacitive network (32, 34).
4. The invention of Claim 1 wherein said load circuit (40) further includes a shunt inductive element (14) coupled to said output of said switching mode circuit (50).
5. The invention of Claim 4 wherein said shunt inductive element (14) includes an inductive bias line for said switching mode circuit (50).
6. The invention of Claim 1 wherein said series inductive-capacitive network (32, 34) includes an inductive element (32) coupled to said output of said switching mode circuit (50).
7. The invention of Claim 6 wherein said series inductive-capacitive network

(32, 34) further includes a capacitive element (34) coupled in series to said inductive element (32).

8. The invention of Claim 1 wherein said load circuit (40) provides a Class-E load.

9. The invention of Claim 1 wherein said load circuit (40) provides a simultaneous high power added efficiency and high power over a broad frequency range.

10. The invention of Claim 1 wherein said load circuit (40) is operable at frequencies in the range of 7 - 11 GHz.

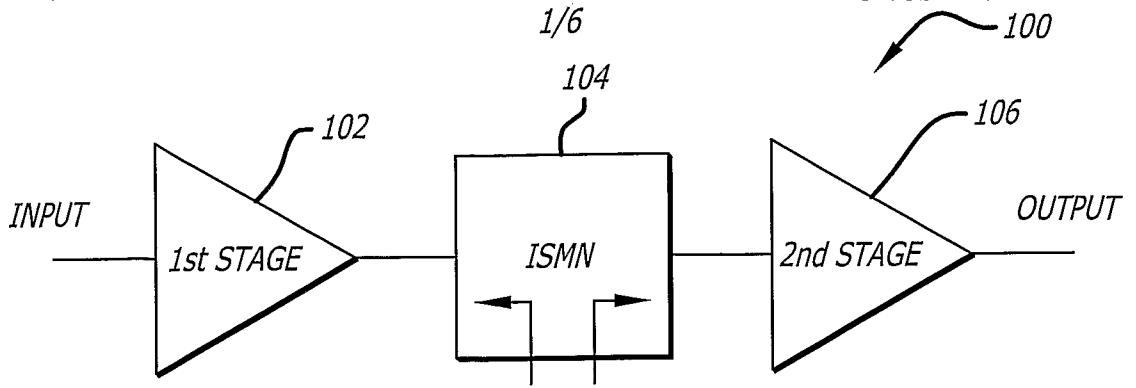


FIG. 1

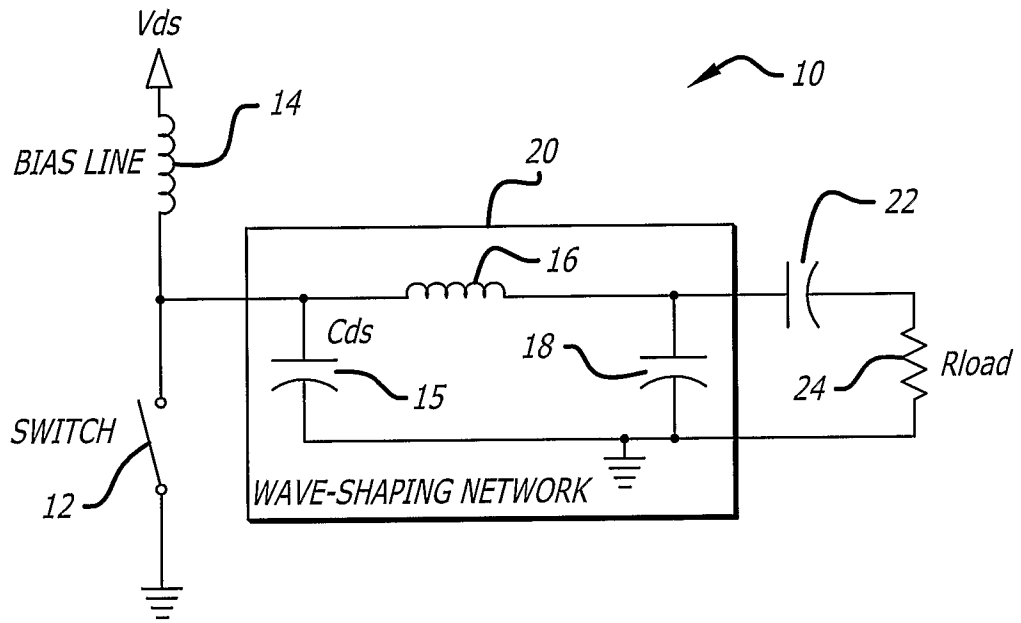


FIG. 2a
(Prior Art)

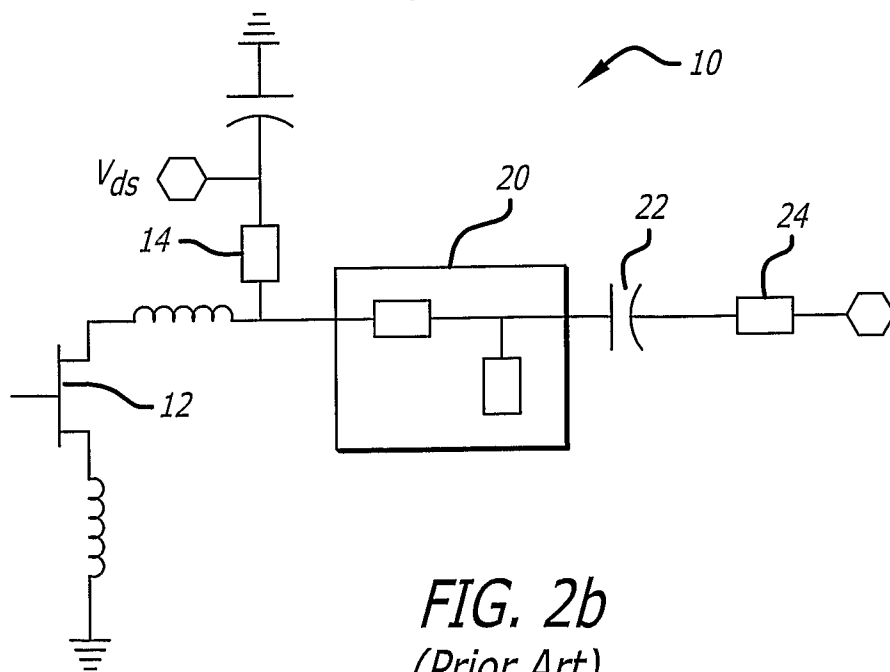


FIG. 2b
(Prior Art)

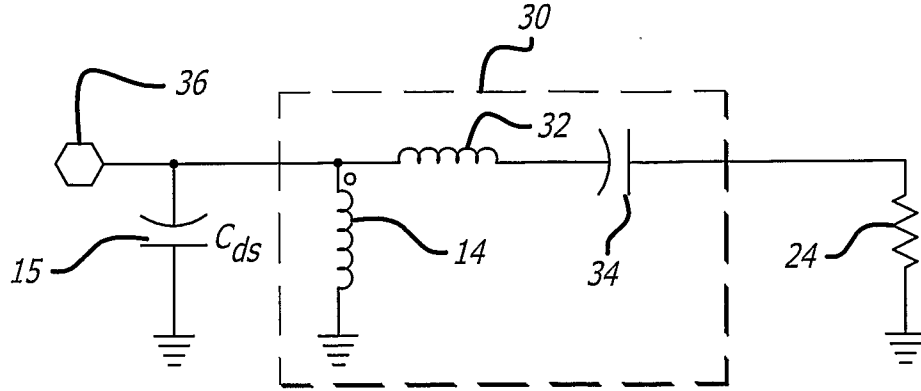


FIG. 3
(Prior Art)

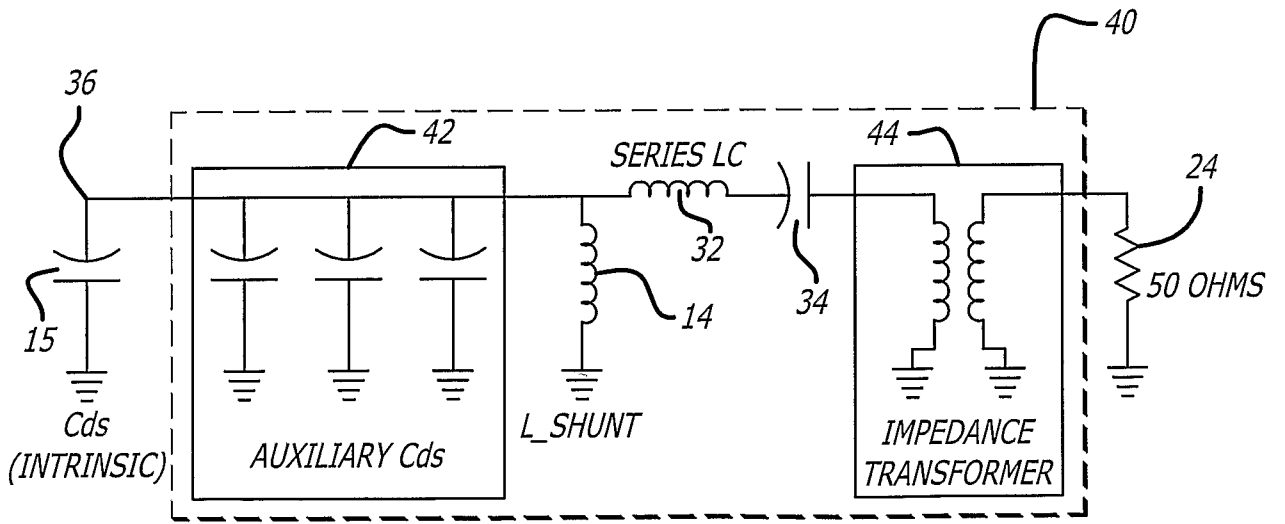


FIG. 4

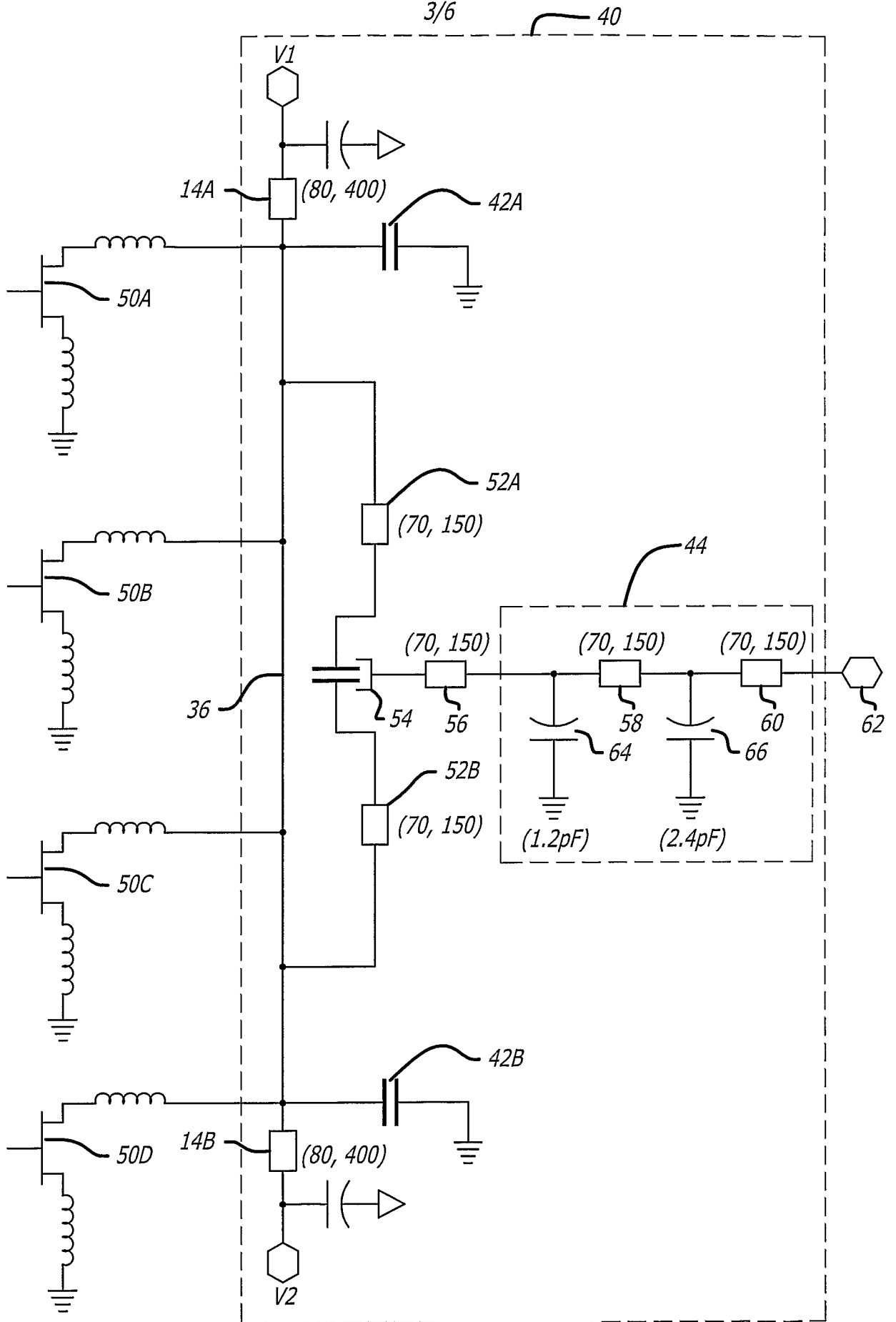


FIG. 5

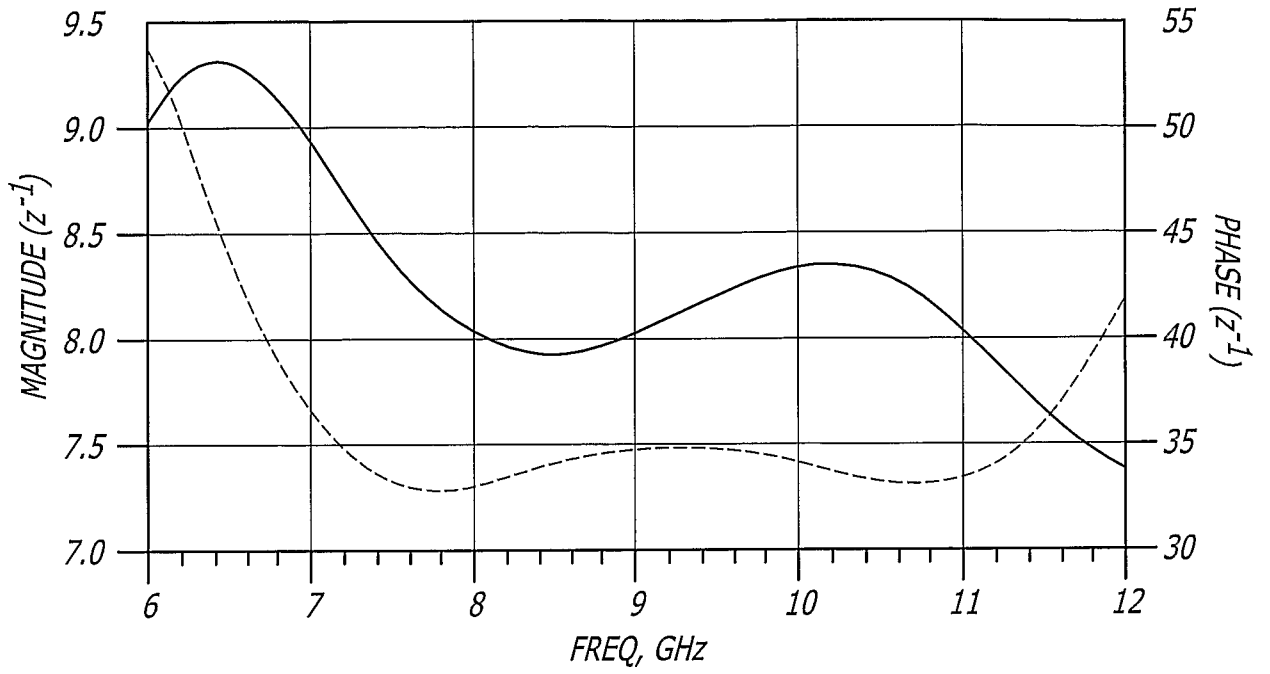


FIG. 6

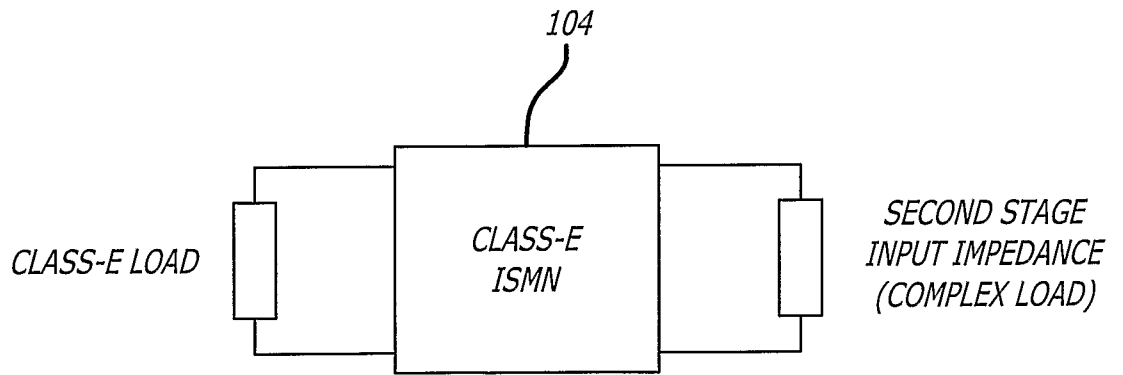


FIG. 7

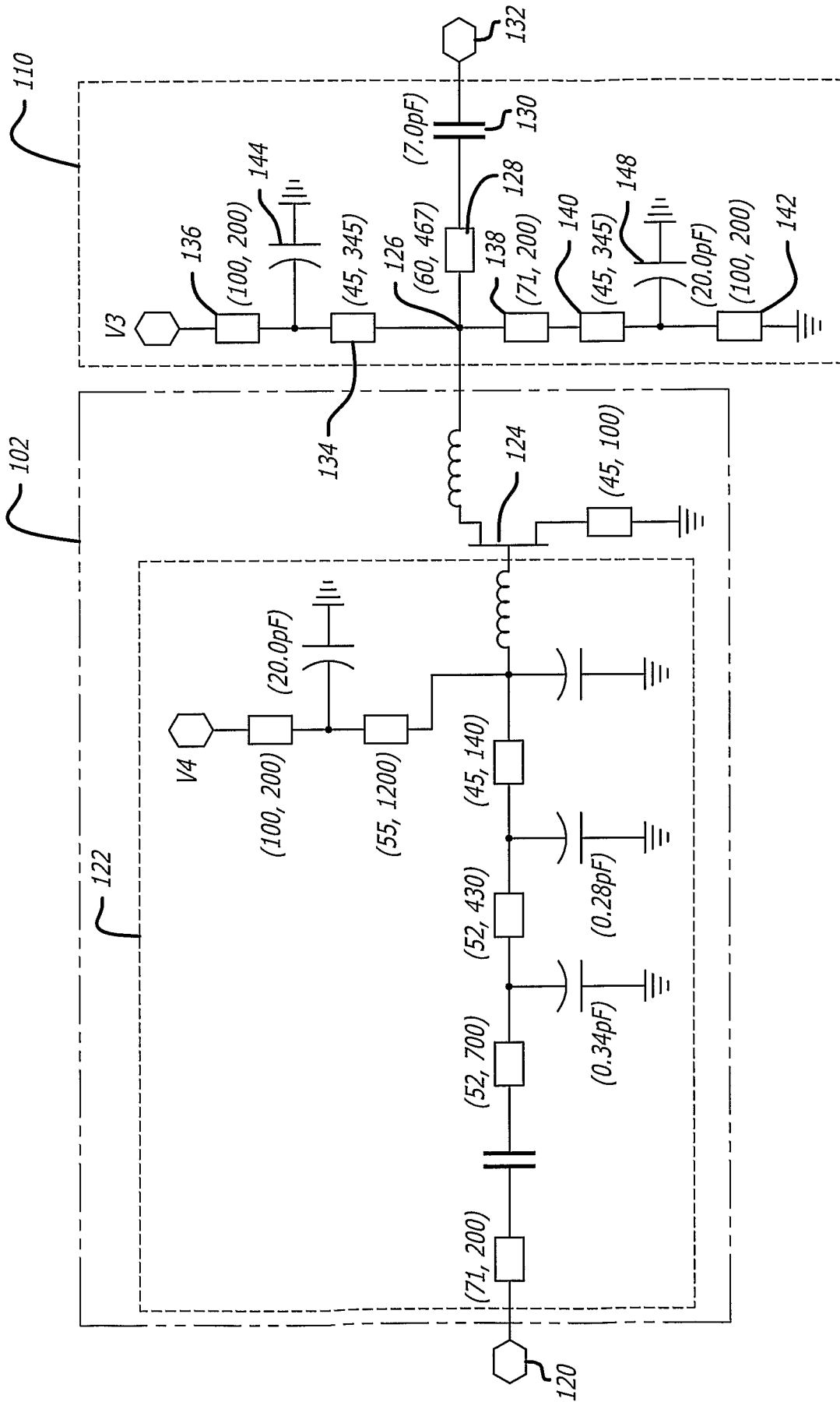


FIG. 8a

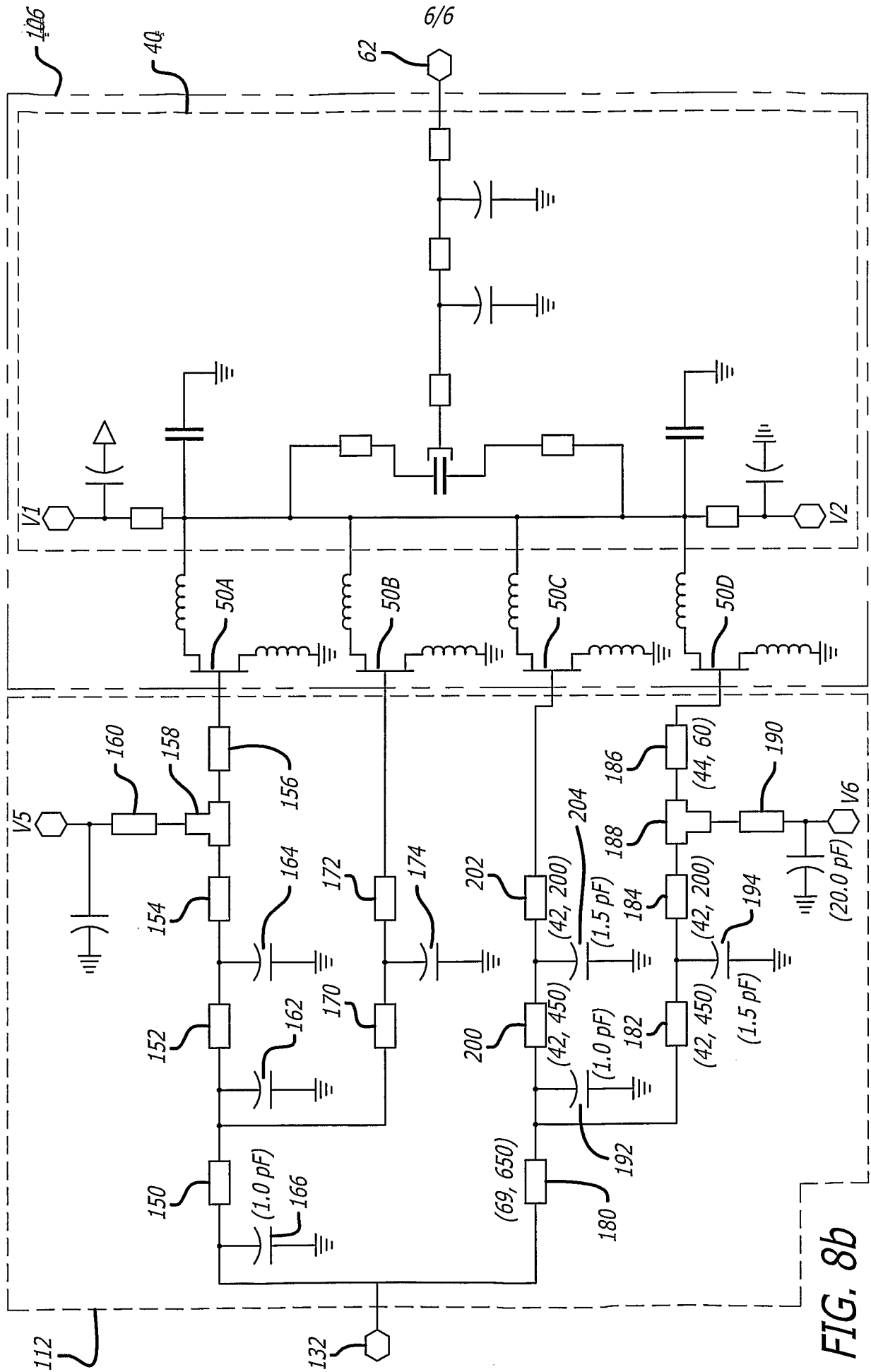


FIG. 8b

INTERNATIONAL SEARCH REPORT

International application No
PCT/US2006/023924

A. CLASSIFICATION OF SUBJECT MATTER
INV. H03F3/217

According to International Patent Classification (IPC) or to both national classification and IPC

B. FIELDS SEARCHED

Minimum documentation searched (classification system followed by classification symbols)
H03F

Documentation searched other than minimum documentation to the extent that such documents are included in the fields searched

Electronic data base consulted during the international search (name of data base and, where practical, search terms used)
EPO-Internal

Category*	Citation of document, with indication, where appropriate, of the relevant passages	Relevant to claim No.
X	<p>GREBENNIKOV A V ET AL INSTITUTE OF ELECTRICAL AND ELECTRONICS ENGINEERS: "CLASS E WITH PARALLEL CIRCUIT - A NEW CHALLENGE FOR HIGH-EFFICIENCY RF AND MICROWAVE POWER AMPLIFIERS" 2002 IEEE MTT-S INTERNATIONAL MICROWAVE SYMPOSIUM DIGEST.(IMS 2002). SEATTLE, WA, JUNE 2 - 7, 2002, IEEE MTT-S INTERNATIONAL MICROWAVE SYMPOSIUM, NEW YORK, NY : IEEE, US, vol. VOL. 3 OF 3, 2 June 2002 (2002-06-02), pages 1627-1630; XP001113917 ISBN: 0-7803-7239-5 figures 1,4,5</p> <p align="center">----- -/--</p>	1,2,4-10

<input checked="" type="checkbox"/> Further documents are listed in the continuation of Box C.	<input checked="" type="checkbox"/> See patent family annex.
<p>* Special categories of cited documents :</p> <p>*A* document defining the general state of the art which is not considered to be of particular relevance</p> <p>*E* earlier document but published on or after the international filing date</p> <p>*L* document which may throw doubts on priority claim(s) or which is cited to establish the publication date of another citation or other special reason (as specified)</p> <p>*O* document referring to an oral disclosure, use, exhibition or other means</p> <p>*P* document published prior to the international filing date but later than the priority date claimed</p> <p>*T* later document published after the international filing date or priority date and not in conflict with the application but cited to understand the principle or theory underlying the invention</p> <p>*X* document of particular relevance; the claimed invention cannot be considered novel or cannot be considered to involve an inventive step when the document is taken alone</p> <p>*Y* document of particular relevance; the claimed invention cannot be considered to involve an inventive step when the document is combined with one or more other such documents, such combination being obvious to a person skilled in the art.</p> <p>*&* document member of the same patent family</p>	
Date of the actual completion of the international search 27 October 2006	Date of mailing of the international search report 03/11/2006
Name and mailing address of the ISA/ European Patent Office, P.B. 5818 Patentlaan 2 NL - 2280 HV Rijswijk Tel. (+31-70) 340-2040, Tx. 31 651 epo nl, Fax: (+31-70) 340-3016	Authorized officer Agerbaek, Thomas

INTERNATIONAL SEARCH REPORT

International application No
PCT/US2006/023924

C(Continuation). DOCUMENTS CONSIDERED TO BE RELEVANT		
Category*	Citation of document, with indication, where appropriate, of the relevant passages	Relevant to claim No.
X	<p>WILKINSON A J ET AL: "TRANSMISSION-LINE LOAD-NETWORK TOPOLOGY FOR CLASS-E POWER AMPLIFIERS" IEEE TRANSACTIONS ON MICROWAVE THEORY AND TECHNIQUES, IEEE SERVICE CENTER, PISCATAWAY, NJ, US, vol. 49, no. 6, PART 2, June 2001 (2001-06), pages 1202-1210, XP001093563 ISSN: 0018-9480 figures 1,3,4,14,15,18</p>	1-10
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